

RoHS

COMPLIANT

FS50SMJ-3-VB Datasheet

N-Channel 150V (D-S) MOSFET

PRODUCT SUMMARY				
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)		
150	0.017 at V _{GS} = 10 V	90 ^a		

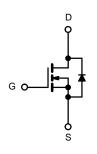
FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

APPLICATIONS

• Isolated DC/DC Converters





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_{C} = 25 °C, unless otherwise noted					
Parameter	-	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	150	v	
Gate-Source Voltage		V _{GS}	± 20	- V	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	1-	90 ^a		
	T _C = 125 °C	I _D	75 ^a	A	
Pulsed Drain Current		I _{DM}	250	~	
Avalanche Current	L = 0.1 mH	I _{AS}	35		
Single Pulse Avalanche Energy ^b	L = 0.1 mm	E _{AS}	61	mJ	
	T _C = 25 °C	P	375 ^c	14/	
Maximum Power Dissipation ^b	T _A = 25 °C ^d	– P _D –	3.75	- W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV	

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

SPECIFICATIONS $T_J = 25$ °	C, unless of	therwise noted				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	150			- V
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		4	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1	
	I _{DSS}	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50	μA
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			А
		V _{GS} = 10 V, I _D = 30 A		0.017		Ω
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.023		
		V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C		0.034		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S
Dynamic ^b	•			•		
Input Capacitance	C _{iss}			5100		pF
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		480		
Reverse Transfer Capacitance	C _{rss}	F		210		
Total Gate Charge ^c	Qg			90	130	nC
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_D = 65 A		23		
Gate-Drain Charge ^c	Q _{gd}			34		
Gate Resistance	R _g		0.5	1.7	3.3	Ω
Turn-On Delay Time ^c	t _{d(on)}			24	35	
Rise Time ^c	t _r	V_{DD} = 100 V, R _L = 1.5 Ω I _D \cong 65 A, V _{GEN} = 10 V, R _g = 2.5 Ω		220	330	ns
Turn-Off Delay Time ^c	t _{d(off)}			45	70	
Fall Time ^c	t _f			200	300	
Source-Drain Diode Ratings and Ch	aracteristics 7	$C = 25 \ ^{\circ}C^{b}$				
Continuous Current	ا _S				65	^
Pulsed Current	I _{SM}			1	140	A
Forward Voltage ^a	V _{SD}	$I_{F} = 65 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V
Reverse Recovery Time	t _{rr}			130	200	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/µs		8	12	А
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

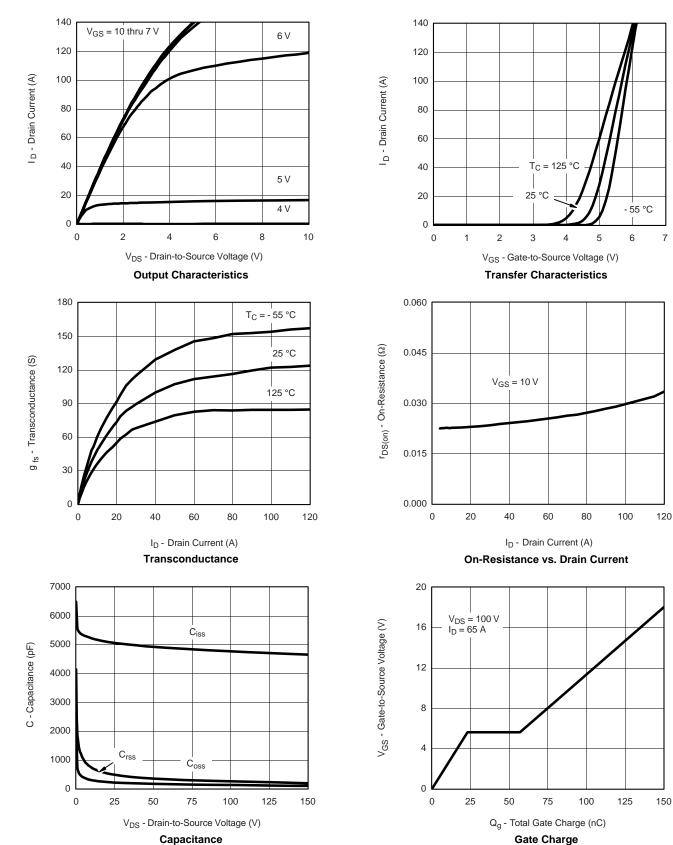
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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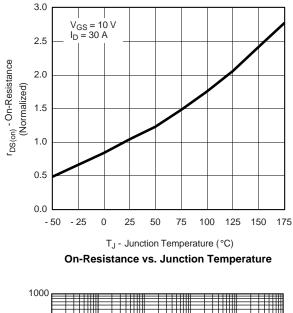


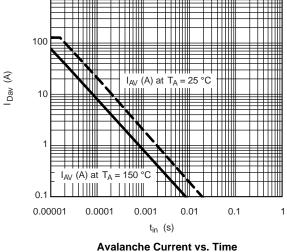


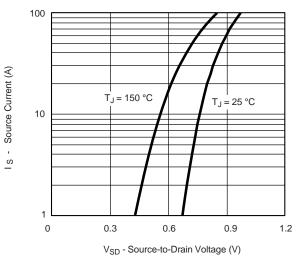
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



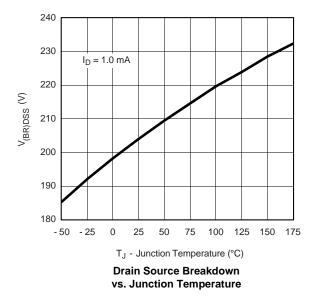
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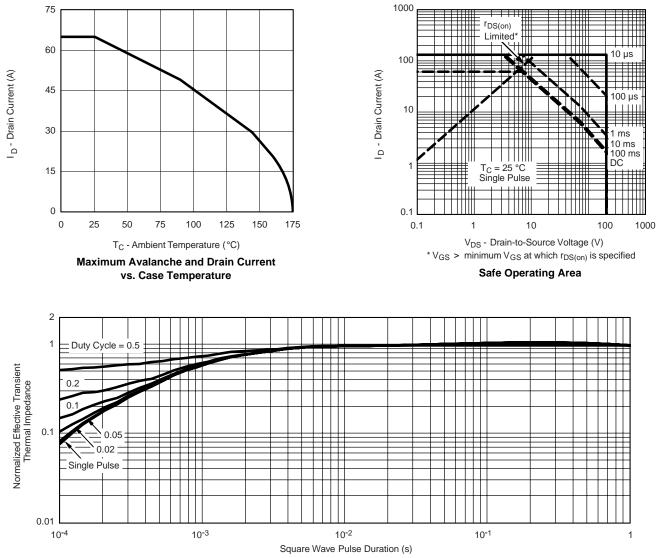


Source-Drain Diode Forward Voltage



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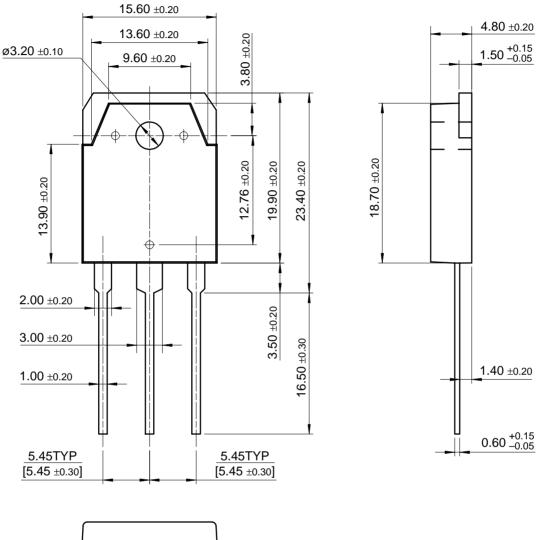
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-3P



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